HALOGEN FREE

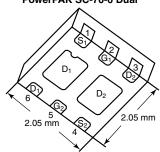
www.vishay.com

Vishay Siliconix

Dual N-Channel 20 V (D-S) MOSFET

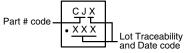
| PRODUCT SUMMARY | | | | | | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|--|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ Max. | I _D (A) ^a | Q _g (Typ.) | | | | | | |
| 20 | 0.043 at V _{GS} = 4.5 V | 4.5 | | | | | | | |
| | 0.045 at V _{GS} = 3.7 V | 4.5 | 3.5 nC | | | | | | |
| | 0.050 at V _{GS} = 2.5 V | 4.5 | 3.5110 | | | | | | |
| | 0.063 at V _{GS} = 1.8 V | 4.5 | | | | | | | |

PowerPAK SC-70-6 Dual



Ordering Information: SiA914ADJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

Marking Code

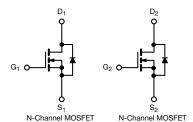


FEATURES

- TrenchFET® Power MOSFET
- Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- 100 % R_a Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Portable Devices such as Smart Phones, Tablet PCs and Mobile Computing
 - Load Switch
 - DC/DC Converter
 - Power Management



| Parameter | | Symbol | Limit | Unit | |
|--|-----------------------------------|----------------|------------------------|------|--|
| Drain-Source Voltage | V _{DS} | 20 | V | | |
| Gate-Source Voltage | V _{GS} | ± 8 | | | |
| | T _C = 25 °C | | 4.5 ^a | | |
| Continuous Dunin Comment (T., 150 °C) | T _C = 70 °C | | 4.5 ^a | | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | I _D | 4.5 ^{a, b, c} | | |
| | T _A = 70 °C | | 4.3 ^{b, c} | А | |
| Pulsed Drain Current (t = 100 μs) | I _{DM} | 30 | | | |
| Continuos Como Durio Diodo Como t | T _C = 25 °C | | 4.5 ^a | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 1.6 ^{b, c} | | |
| | T _C = 25 °C | | 7.8 | | |
| Maniana Danian Dissipation | T _C = 70 °C | | 5 | 14/ | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 1.9 ^{b, c} | W | |
| | T _A = 70 °C | | 1.2 ^{b, c} | | |
| Operating Junction and Storage Temperatu | T _J , T _{stg} | - 55 to 150 | °C | | |
| Soldering Recommendations (Peak Temper | | 260 | | | |

| THERMAL RESISTANCE RATINGS | | | | | | | | | |
|----------------------------------|--------------|-------------------|---------|---------|------|--|--|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | | | |
| | | R_{thJA} | 52 | 65 | °C/W | | | | |
| Maximum Junction-to-Case (Drain) | Steady State | R _{thJC} | 12.5 | 16 C/W | | | | | |

Notes

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 110 °C/W.



Vishay Siliconix

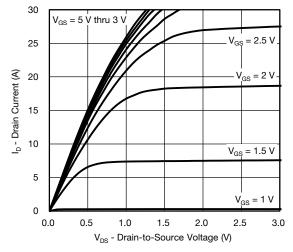
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | | |
|---|---|---|------|-------|-------|-------|--|--|
| Static | | | | I. | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$ | 20 | | | V | | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | | | 18 | | 14/00 | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 2.5 | | mV/°C | | |
| Gate-Source Threshold Voltage | V _{GS(th}) | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 0.4 | | 0.9 | V | | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | | | ± 100 | nA | | |
| Zana Oala Vallana Baria Oanad | | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μΑ | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C | | | 10 | | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | 10 | | | Α | | |
| | . , | $V_{GS} = 4.5 \text{ V}, I_D = 3.7 \text{ A}$ | | 0.035 | 0.043 | Ω | | |
| Duain Carrier On Chata Basistanas | Б | V _{GS} = 3.7 V, I _D = 3 A | | 0.036 | 0.045 | | | |
| Drain-Source On-State Resistance ^a | $R_{DS(on)}$ | $V_{GS} = 2.5 \text{ V}, I_D = 3 \text{ A}$ | | 0.040 | 0.050 | | | |
| | | V _{GS} = 1.8 V, I _D = 1 A | | 0.047 | 0.063 | | | |
| Forward Transconductance ^a | 9 _{fs} | $V_{DS} = 10 \text{ V}, I_D = 3.7 \text{ A}$ | | 18 | | S | | |
| Dynamic ^b | | | | | | | | |
| Input Capacitance | C _{iss} | | | 470 | | pF | | |
| Output Capacitance | C _{oss} | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 75 | | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 26 | | | | |
| Total Cata Chavas | Q _g | $V_{DS} = 10 \text{ V}, V_{GS} = 8 \text{ V}, I_D = 6 \text{ A}$ | | 8.2 | 12.5 | nC | | |
| Total Gate Charge | | | | 4.6 | 7 | | | |
| Gate-Source Charge | | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 6 \text{ A}$ | | 0.65 | | | | |
| Gate-Drain Charge | Q _{gd} | | | 0.6 | | | | |
| Gate Resistance | R _g | f = 1 MHz | 0.6 | 3 | 6 | Ω | | |
| Turn-On Delay Time | t _{d(on)} | | | 7 | 15 | | | |
| Rise Time | t _r | $V_{DD} = 10 \text{ V}, R_{L} = 2.1 \Omega$ | | 20 | 40 | | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong 4.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$ | | 25 | 50 | | | |
| Fall Time | t _f | | | 5 | 10 | | | |
| Turn-On Delay Time | t _{d(on)} | | | 5 | 10 | ns | | |
| Rise Time | t _r | $V_{DD} = 10 \text{ V}, R_{L} = 2.1 \Omega$ | | 5 | 10 | | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong 4.8 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$ | | 20 | 40 | | | |
| Fall Time | t _f | | | 5 | 10 | | | |
| Drain-Source Body Diode Characteristic | s | | | | | | | |
| Continuous Source-Drain Diode Current | ous Source-Drain Diode Current I _S | | | | 4.5 | ۸ | | |
| Pulse Diode Forward Current (t = 100 μs) | I _{SM} | | | | 30 | Α | | |
| Body Diode Voltage | | | | 0.85 | 1.2 | V | | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 9.5 | 20 | ns | | |
| Body Diode Reverse Recovery Charge | Q _{rr} | 1 40 A 41/4 400 A / - T 05 00 | | 3 | 10 | nC | | |
| Reverse Recovery Fall Time | ta | $I_F = 4.8 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | | 5 | | | | |
| Reverse Recovery Rise Time | t _b | | | 4.5 | | ns | | |

Notes

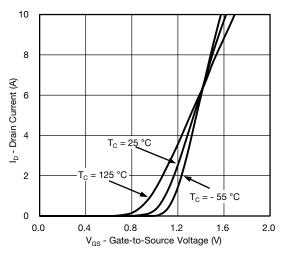
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

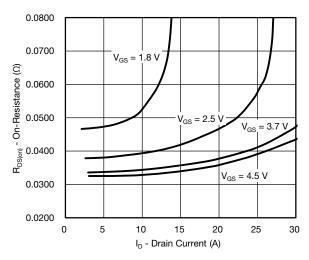




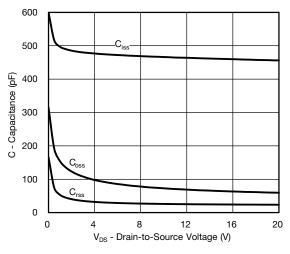
Output Characteristics



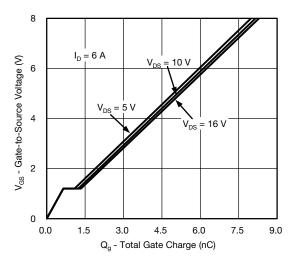
Transfer Characteristics



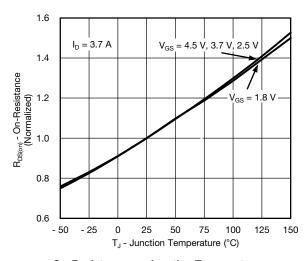
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

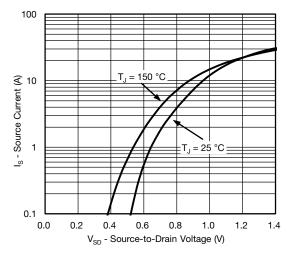


Gate Charge

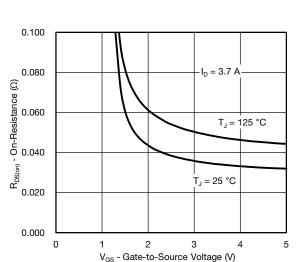


On-Resistance vs. Junction Temperature

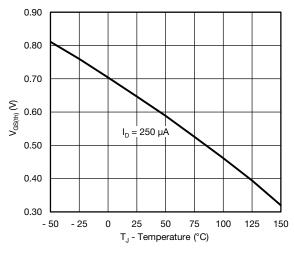




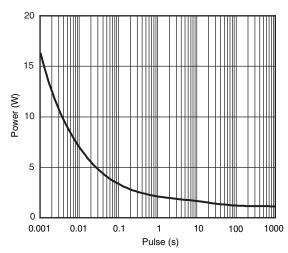
Source-Drain Diode Forward Voltage



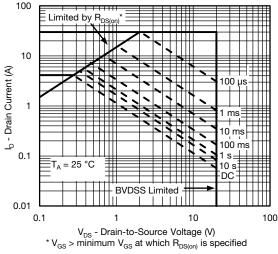
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

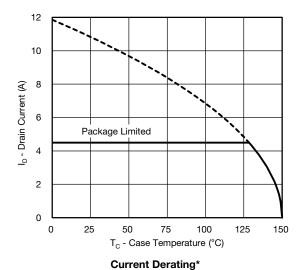


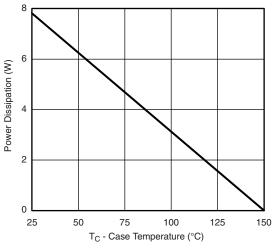
Single Pulse Power (Junction-to-Ambient)



Safe Operating Area, Junction-to-Ambient



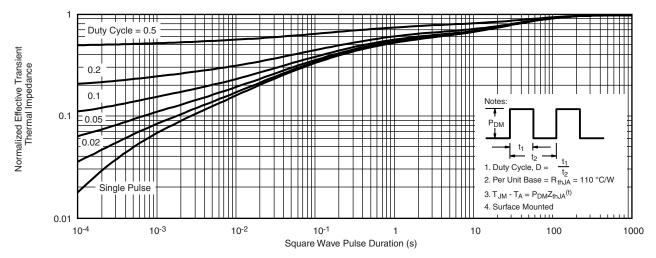




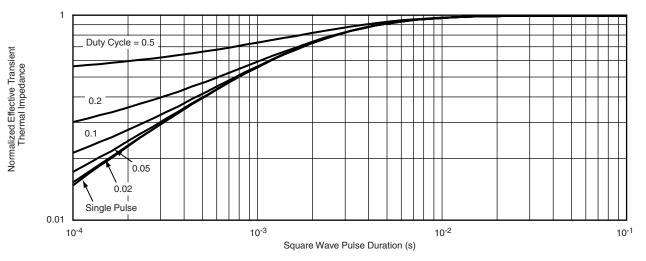
Power Derating

^{*} The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62872.





Vishay Siliconix

PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

| | SINGLE PAD | | | | | | DUAL PAD | | | | | |
|-----|------------|----------------------------|-------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-------|-------|
| DIM | M | MILLIMETERS INCHES MILLIMI | | ILLIMETER | LIMETERS | | INCHES | | | | | |
| | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max |
| Α | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 |
| A1 | 0 | - | 0.05 | 0 | - | 0.002 | 0 | - | 0.05 | 0 | - | 0.002 |
| b | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 |
| С | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 |
| D1 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 | 0.513 | 0.613 | 0.713 | 0.020 | 0.024 | 0.028 |
| D2 | 0.135 | 0.235 | 0.335 | 0.005 | 0.009 | 0.013 | | | | | | |
| Е | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 |
| E1 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 |
| E2 | 0.345 | 0.395 | 0.445 | 0.014 | 0.016 | 0.018 | | | | | | |
| E3 | 0.425 | 0.475 | 0.525 | 0.017 | 0.019 | 0.021 | | | | | | |
| е | | 0.65 BSC | | | 0.026 BSC | ; | 0.65 BSC | | | 0.026 BSC | | |
| K | | 0.275 TYP | | | 0.011 TYP | | 0.275 TYP | | | 0.011 TYP | | |
| K1 | | 0.400 TYP | | 0.016 TYP | | 0.320 TYP | | | 0.013 TYP | | | |
| K2 | | 0.240 TYP | | 0.009 TYP | | 0.252 TYP | | 0.010 TYP | | | | |
| К3 | | 0.225 TYP 0.009 TYP | | | | • | | • | • | | | |
| K4 | | 0.355 TYP | | 0.014 TYP | | | | | | | | |
| L | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 |
| T | | | | | | | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 |

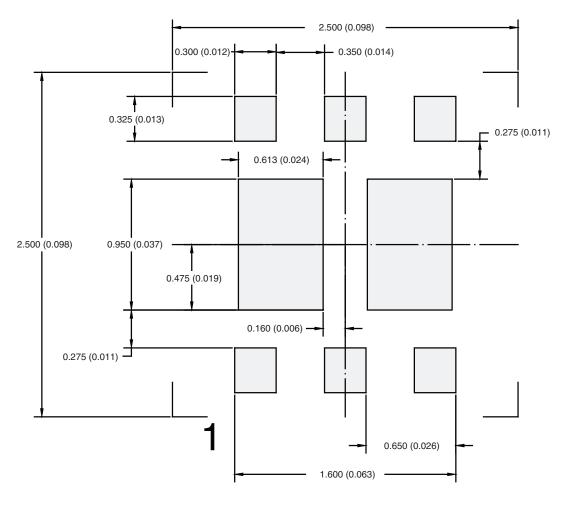
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

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Vishay

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Revision: 02-Oct-12 Document Number: 91000